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July 2014

# Integrated P-Channel PowerTrench<sup>®</sup> MOSFET and Schottky Diode

# –20V, –3.1A, 95m $\Omega$

FDFMA2P029Z

# Features

## MOSFET

- Max  $r_{DS(on)}$  = 95m $\Omega$  at  $V_{GS}$  = -4.5V,  $I_D$  = -3.1A
- Max  $r_{DS(on)}$  = 141m $\Omega$  at V<sub>GS</sub> = -2.5V, I<sub>D</sub> = -2.5A
- HBM ESD protection level > 2.5kV (Note 3)

#### Schottky

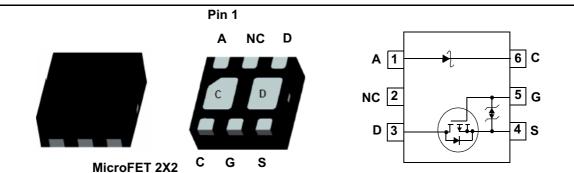
- V<sub>F</sub> < 0.37V @ 500mA
- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- RoHS Compliant



# **General Description**

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultraportable applications. It features a MOSFET with very low onstate resistance and an independently connected low forward voltage schottky diode allows for minimum conduction losses.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		-20	V	
V <sub>GS</sub>	Gate to Source Voltage		±12	V	
1	Drain Current -Continuous	(Note 1a)	-3.1	•	
D	-Pulsed		-6	A	
Р	Power Dissipation	(Note 1a)	1.4	w	
P <sub>D</sub>		(Note 1b)	0.7	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	
V <sub>RRM</sub>	Schottky Repetitive Peak Reverse Voltage		20	V	
lo	Schottky Average Forward Current		2	Α	

#### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	86	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	173	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1c)	86	C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1d)	140	

#### Package Marking and Ordering Information

Dev	vice Marking	Device	Package	Reel Size	Tape Width	Quantity
	.P29	FDFMA2P029Z	MicroFET 2X2	7"	8mm	3000 units

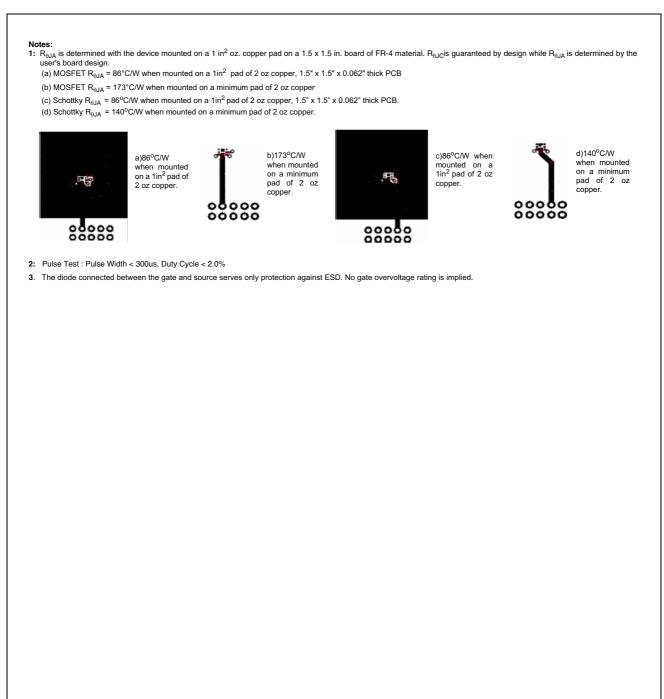
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	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{\rm D} = -250 \mu \text{A}, V_{\rm GS} = 0^{\circ}$	V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to 25°C			-12		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$				-1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±12V, $V_{DS}$ = 0V				±10	μA
On Chara	octeristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250$	μA	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	te to Source Threshold Voltage $I_{\rm D} = -250 \mu A$ referenced to 25°C.			4		mV/°C
					60	95	
r <sub>DS(on)</sub>	Static Drain to Source On-Resistance	$V_{GS} = -2.5V, I_{D} = -2$			88	141	mΩ
		$V_{GS} = -4.5V, I_D = -3.1A, T_J = 125^{\circ}C$			87	140	
9fs	Forward Transconductance	$V_{DS} = -10V, I_D = -3.1$	IA		-11		S
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance				540	720	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -10V, V_{GS} = 0V$	/,		120	160	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz	-		100	150	pF
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	V <sub>DD</sub> = -10V, I <sub>D</sub> = -1A			13 11	24 20	ns ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$-V_{GS}^{} = -4.5V, R_{GEN} =$	6Ω		37	59	ns
t <sub>f</sub>	Fall Time				36	58	ns
ч	THOLO	V <sub>DD</sub> = -10V, I <sub>D</sub> = -3.1A			7	10	nC
	Total Gate Charge	$V_{DD} = -10V. I_{D} = -3.1$	$V_{GS} = -4.5V$				
Q <sub>g(TOT)</sub> Q <sub>gs</sub>	Gate to Source Gate Charge				1.1		nC
Q <sub>g(TOT)</sub>			-		1.1 2.4		nC nC
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate to Source Gate Charge		-				
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = -4.5V$				-1.1	
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = -4.5V$	(Note 2)			-1.1 -1.2	nC
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Maximum Continuous Drain-Source Diod	$V_{GS} = -4.5V$ le Forward Current	(Note 2)		2.4		nC A

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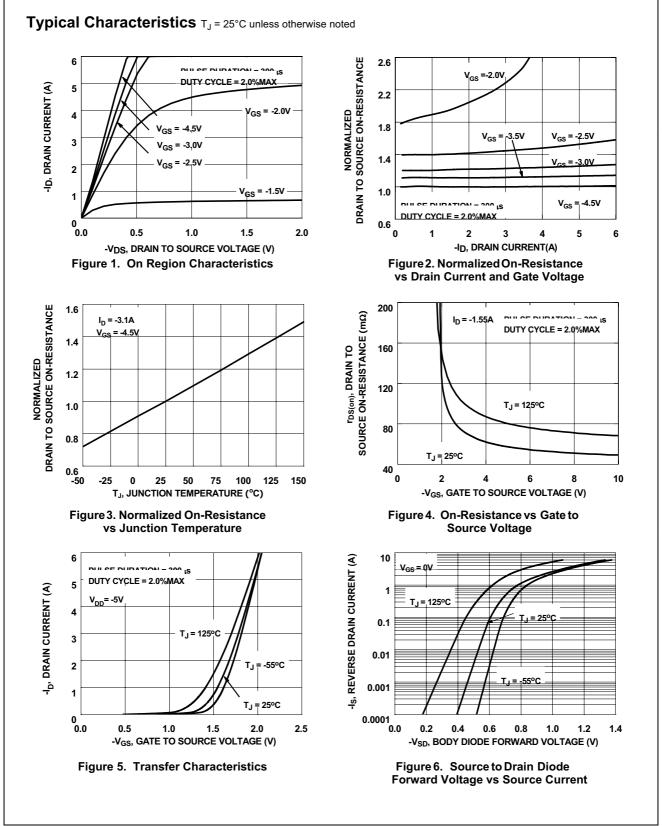
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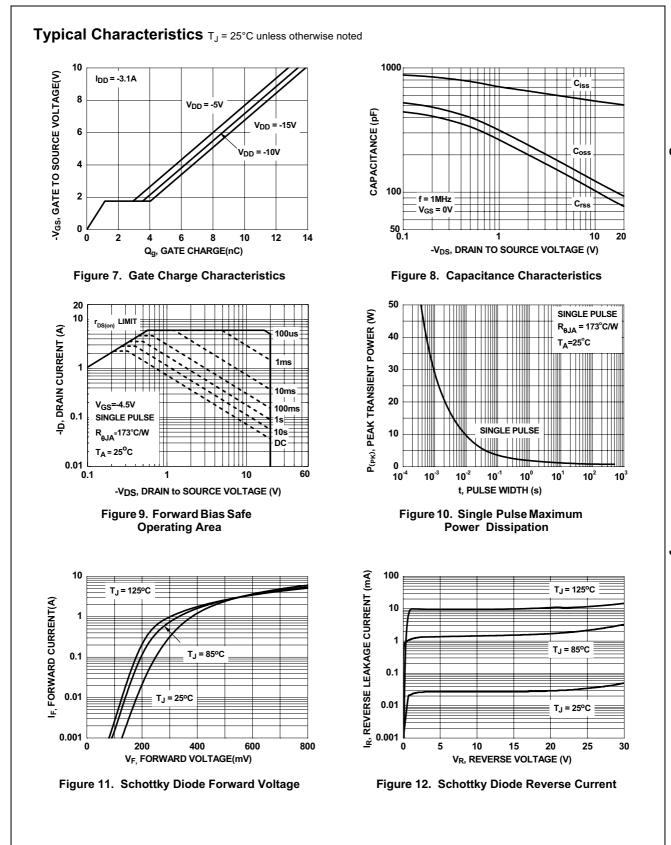


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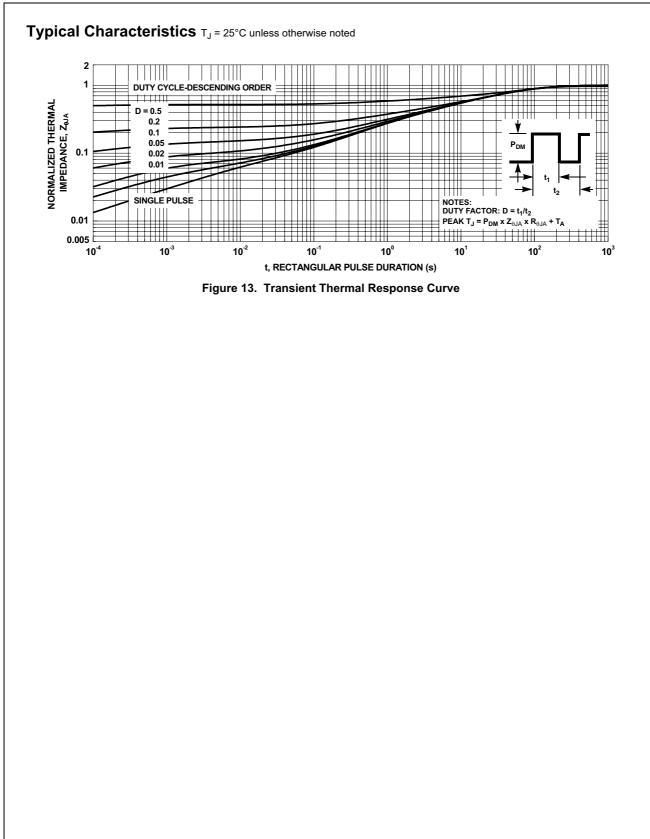
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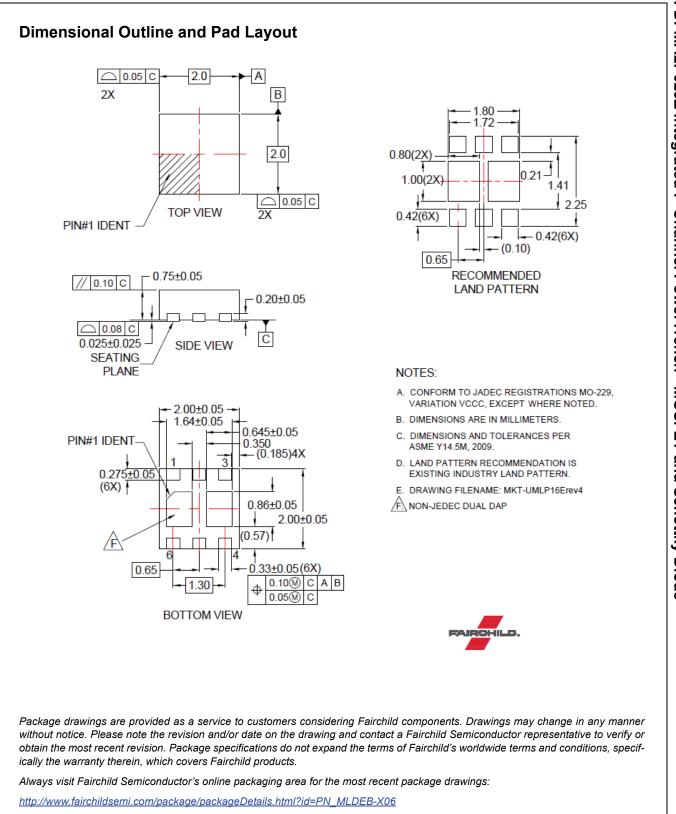
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